

1. General description

Ultrafast power diode in a SOT404 (D2PAK) surface-mountable plastic package.

2. Features and benefits

- Fast switching
- High thermal cycling performance
- Low forward volt drop
- Low thermal resistance
- Soft recovery minimizes power-consuming oscillations
- Surface mountable package

3. Applications

- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)
- · Output rectifiers in high-frequency switched-mode power supplies

4. Quick reference data

Table	1.	Quick	reference	data
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _R	reverse voltage	DC	-	-	500	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 123 °C; SQW; <u>Fig. 1;</u> <u>Fig. 2</u>	-	-	9	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 123 °C; SQW	-	-	18	A
I _{FSM}	non-repetitive peak forward current	t _p = 10 ms; T _{j(init)} = 25 °C; SIN	-	-	100	А
		t _p = 8.3 ms; T _{j(init)} = 25 °C; SIN	-	-	110	А
Static chara	acteristics	·	· ·			
V _F	forward voltage	I _F = 8 A; T _j = 150 °C; <u>Fig. 4</u>	-	0.9	1.03	V
		I _F = 8 A; T _j = 25 °C; <u>Fig. 4</u>	-	1.05	1.25	V
		I _F = 20 A; T _j = 25 °C; <u>Fig. 4</u>	-	1.2	1.4	V
Dynamic ch	naracteristics					
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/s; T _i = 25 °C; <u>Fig. 5</u> ; <u>Fig. 6</u>	-	50	60	ns

Ultrafast power diode

Version

SOT404

5. Pinning information

Table 2.	Pinning in	formation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	n.c.	no connection	mb	К — Ң — А
2	К	cathode[1]		001aaa020
3	А	anode		
mb	к	mounting base; cathode		
			D2PAK (SOT404)	

[1] it is not possible to make a connection to Pin 2 of the SOT404 package

6. Ordering information

Table 3. Ordering information Type number Package Name Description BYV29B-500 D2PAK plastic single-ended surface-mounted package (D2PAK); 3

leads (one lead cropped)

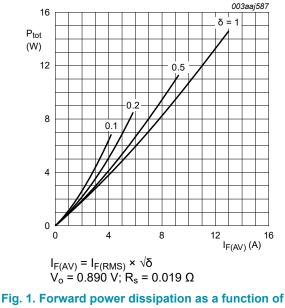
BYV29B-500

7. Limiting values

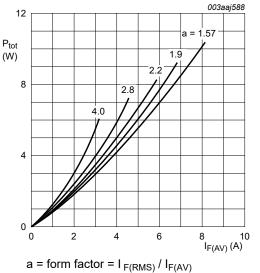
Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	500	V
V _{RWM}	crest working reverse voltage		-	500	V
V _R	reverse voltage	DC	-	500	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 123 °C; SQW; <u>Fig. 1</u> ; <u>Fig. 2</u>	-	9	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _{mb} ≤ 123 °C; SQW	-	18	A
I _{FSM}	non-repetitive peak	t _p = 10 ms; T _{j(init)} = 25 °C; SIN	-	100	А
	forward current	t _p = 8.3 ms; T _{j(init)} = 25 °C; SIN	-	110	А
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	150	°C



average forward current; square waveform; maximum values



 $V_{o} = 0.890 \text{ V}; \text{ R}_{s} = 0.019 \Omega$

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

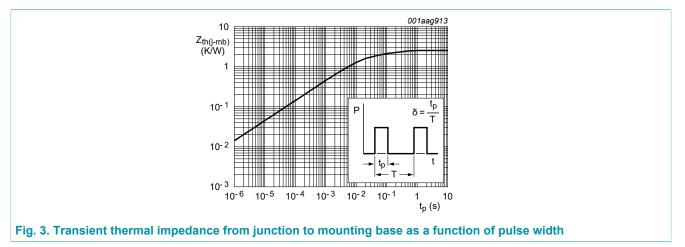


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8. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 3		-	-	2.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	[1]	-	50	-	K/W

[1] Device mounted on a FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

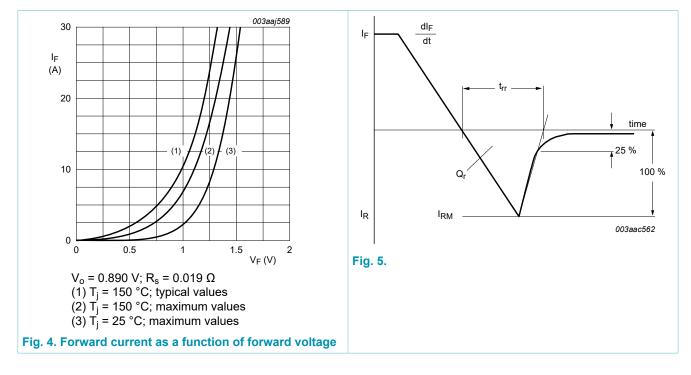


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9. Characteristics

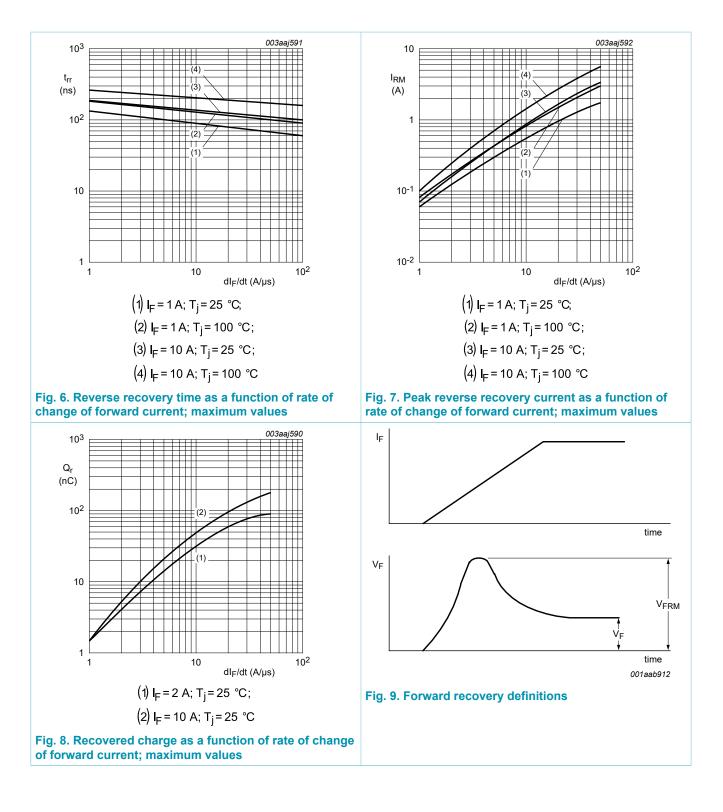
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V _F	forward voltage	I _F = 8 A; T _j = 150 °C; <u>Fig. 4</u>	-	0.9	1.03	V
		I _F = 8 A; T _j = 25 °C; <u>Fig. 4</u>	-	1.05	1.25	V
		I _F = 20 A; T _j = 25 °C; <u>Fig. 4</u>	-	1.2	1.4	V
I _R	reverse current	V _R = 500 V; T _j = 25 °C	-	2	50	μA
		V _R = 500 V; T _j = 100 °C	-	0.1	0.35	mA
Dynamic ch	naracteristics			·		
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; \text{ V}_R = 30 \text{ V}; \text{ d}_F/\text{d}t = 100 \text{ A/s}; T_j = 25 °C; Fig. 5; Fig. 6$	-	50	60	ns
I _{RM}	peak reverse recovery current	$ I_F = 10 \text{ A}; \text{V}_R = 30 \text{ V}; \text{d}_F/\text{d}\text{t} = 50 \text{ A/s}; $	-	4	5.5	A
Qr	recovered charge	I _F = 2 A; V _R = 30 V; dI _F /dt = 20 A/s; T _j = 25 °C; <u>Fig. 8</u> ; <u>Fig. 5</u>	-	40	60	nC
V _{FR}	forward recovery voltage	I _F = 10 A; dI _F /dt = 10 A/s; T _j = 25 °C; <u>Fig. 9</u>	-	2.5	-	V



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BYV29B-500

Ultrafast power diode



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10. Package outline

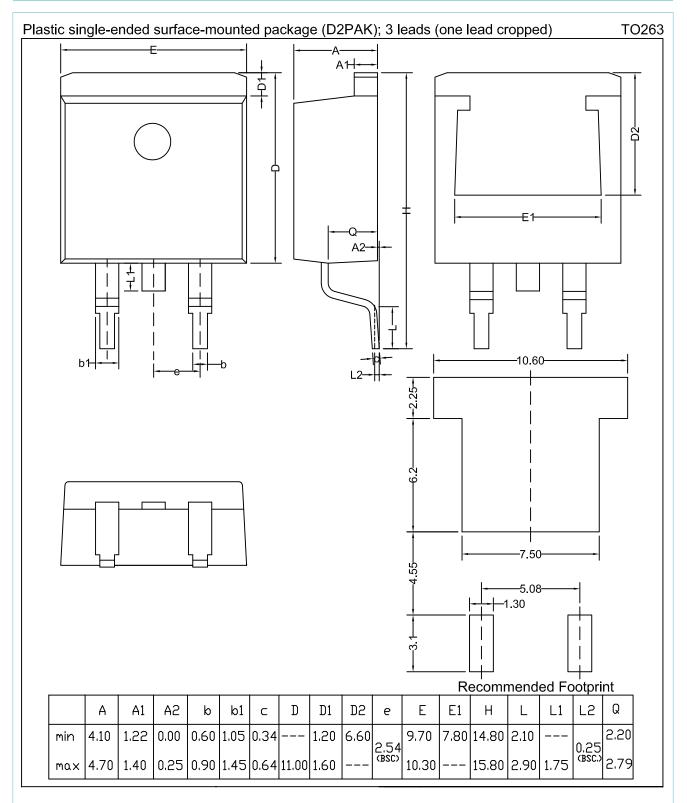


Fig. 10. Package outline D2PAK (SOT404)

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11. Legal information

Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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